

Infrared Emitting Diodes(GaAs)

KODENSHI

EL - 23G

The EL - 23G, a high - power GaAs IRED mounted in a clear sidelooking package, is compact, low profile, and easy to mount.

FEATURES

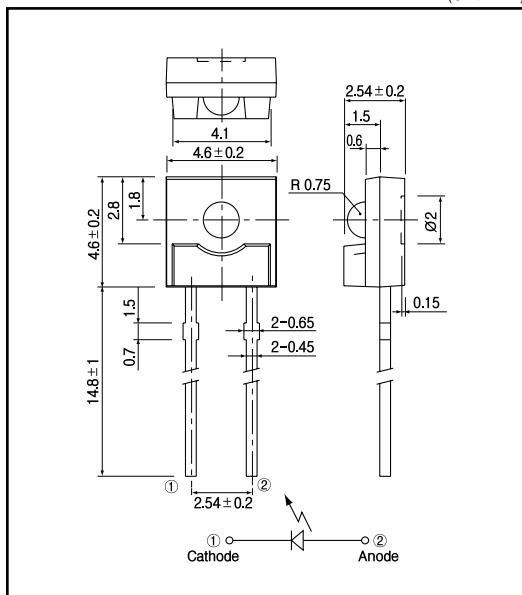
- Compact
- Low profile package
- Low - cost
- Sidelooking plastic package

APPLICATIONS

- Photointerrupters
- Optical switches
- Toys

DIMENSIONS

(Unit : mm)

**MAXIMUM RATINGS**

(Ta=25 °C)

Item	Symbol	Rating	Unit
Reverse voltage	V _R	5	V
Forward current	I _F	60	mA
Pulse forward current ^{*1}	I _{FP}	1	A
Power dissipation	P _D	100	mW
Operating temp.	T _{opr.}	- 20 ~ + 100	
Storage temp.	T _{stg.}	- 30 ~ + 100	
Soldering temp. ^{*2}	T _{sol.}	240	

^{*1}. pulse width : tw 100 μsec. period : T=10msec.^{*2}. For MAX.5 seconds at the position of 2 mm from the package**ELECTRO-OPTICAL CHARACTERISTICS**

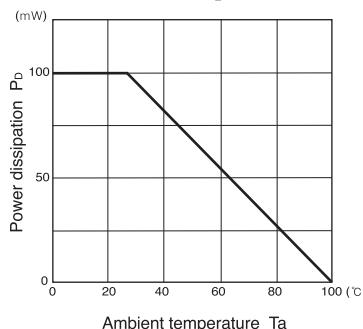
(Ta=25 °C)

Item	Symbol	Conditions	Min.	Typ.	Max.	Unit.
Forward voltage	V _F	I _F =60mA		1.3	1.6	V
Reverse current	I _R	V _R =5V			10	μA
Capacitance	C _t	f=1MHz		25		pF
Radiant intensity	P _O	I _F =60mA		2.0		mW/sr
Peak emission wavelength	λ	I _F =60mA		940		nm
Spectral bandwidth 50%		I _F =60mA		50		nm
Half angle				± 30		deg.

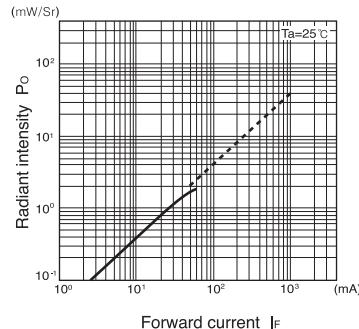
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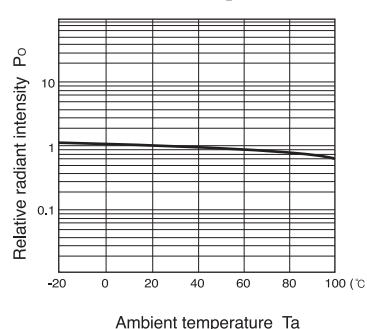
**Power dissipation Vs.
Ambient temperature**



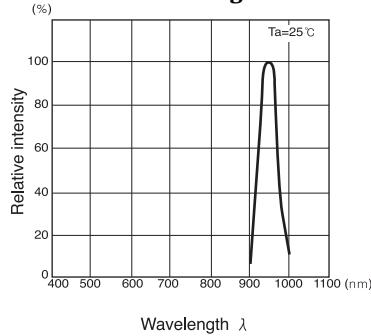
**Radiant intensity Vs.
Forward current**



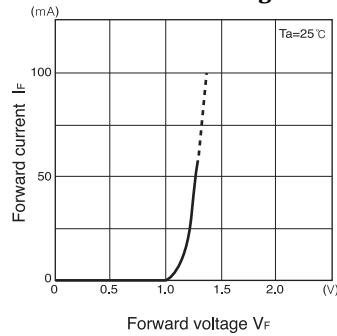
**Relative radiant intensity Vs.
Ambient temperature**



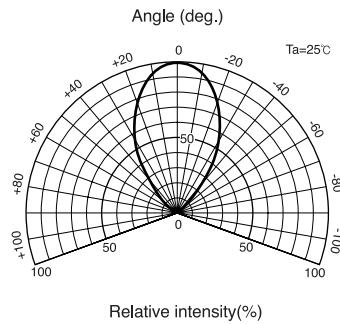
**Relative intensity Vs.
Wavelength**



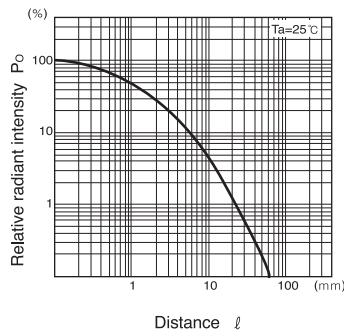
**Forward current vs.
Forward voltage**



Radiant Pattern



**Relative radiant intensity Vs.
Distance**



Relative radiant intensity Vs.
Distance test method

